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Team Nexperia

Common-mode EMI filter for differential channels with integrated ESD protection

Rev. 2 — 28 April 2014

**Product data sheet** 

### 1. Product profile

### 1.1 General description

The devices are common-mode ElectroMagnetic Interference (EMI) filters with integrated ElectroStatic Discharge (ESD) protection for two and three differential channels. The devices are designed to provide low insertion loss for differential high-speed signals on each channel while unwanted common-mode signals are attenuated.

Each differential channel incorporates two signal lines that are coupled by integrated coils. Diodes provide protection to downstream components from ESD voltages up to  $\pm 15$  kV on each signal line.

Table 1. Product overview

· ·		Package				
	channels	Name	Version			
PCMF2DFN1	2	DFN2520-9	SOT1333-1	XSON9		
PCMF3DFN1	3	DFN4020-14	SOT1334-1	XSON14		

### 1.2 Features and benefits

- Two and three differential channels common-mode EMI filter with integrated ESD protection
- Superior common-mode suppression over a wide frequency range
- ESD protection up to ±15 kV contact discharge according to IEC 61000-4-2
- Maximum package height: 0.5 mm

### 1.3 Applications

- Smartphone, cellular and cordless phone
- MIPI D-PHY as used in Camera Serial Interface (CSI) and Display Serial Interface (DSI)
- General-purpose EMI and Radio-Frequency Interference (RFI) filter and downstream ESD protection
- Tablet PC and Mobile Internet Device (MID)
- High-Definition Multimedia Interface (HDMI)



# 2. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
PCMF	2DFN1 (SOT133	3-1)		
1	CH1_IN+	input channel 1		
2	CH1_IN-	input channel 1	1 9	2 8
3	GND	ground	2 8	2
4	CH2_IN+	input channel 2	3	
5	CH2_IN-	input channel 2	4 7	本 本
6	CH2_OUT-	output channel 2	5 6	
7	CH2_OUT+	output channel 2	T	± 3
8	CH1_OUT-	output channel 1	Transparent top view <b>DFN2520-9</b>	47
9	CH1_OUT+	output channel 1	DI NESES S	5
PCMF	3DFN1 (SOT133	4-1)		
1	CH1_IN+	input channel 1		
2	CH1_IN-	input channel 1	114	14
3	GND_1	ground 1	2 13	2
4	CH2_IN+	input channel 2	3	<u> </u>
5	CH2_IN-	input channel 2	412	本 本
6	GND_2	ground 2	511	
7	CH3_IN+	input channel 3	6	± 3
8	CH3_IN-	input channel 3	710	4
9	CH3_OUT-	output channel 3	8 9	5
10	CH3_OUT+	output channel 3	T	
11	CH2_OUT-	output channel 2	Transparent top view	
12	CH2_OUT+	output channel 2	DFN4020-14	4 4
13	CH1_OUT-	output channel 1		
14	CH1_OUT+	output channel 1		7 8 10 9
				aaa-007384

PCMF2DFN1\_PCMF3DFN1

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Common-mode EMI filter for differential channels with ESD protection

# 3. Ordering information

Table 3. Ordering information

Type number	Package	Package					
	Name	Description	Version				
PCMF2DFN1	DFN2520-9	plastic extremely thin small outline package; no leads; 9 terminals; body 2 × 2.5 × 0.5 mm	SOT1333-1				
PCMF3DFN1	DFN4020-14	plastic extremely thin small outline package; no leads; 14 terminals; body 2 × 4 × 0.5 mm	SOT1334-1				

## 4. Marking

Table 4. Marking codes

Type number	Marking code
PCMF2DFN1	MP1
PCMF3DFN1	CMFMP1

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		-0.5	5	V
V <sub>ESD</sub>	electrostatic discharge voltage	IEC 61000-4-2, level 4; all input pins to ground			
		contact discharge	-15	15	kV
		air discharge	-15	15	kV
		IEC 61000-4-2, level 4; all output pins to ground			
		contact discharge	-2	2	kV
		air discharge	-2	2	kV
T <sub>stg</sub>	storage temperature		-55	+125	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C

### 6. Characteristics

### 6.1 Channel characteristics

Table 6. Channel characteristics

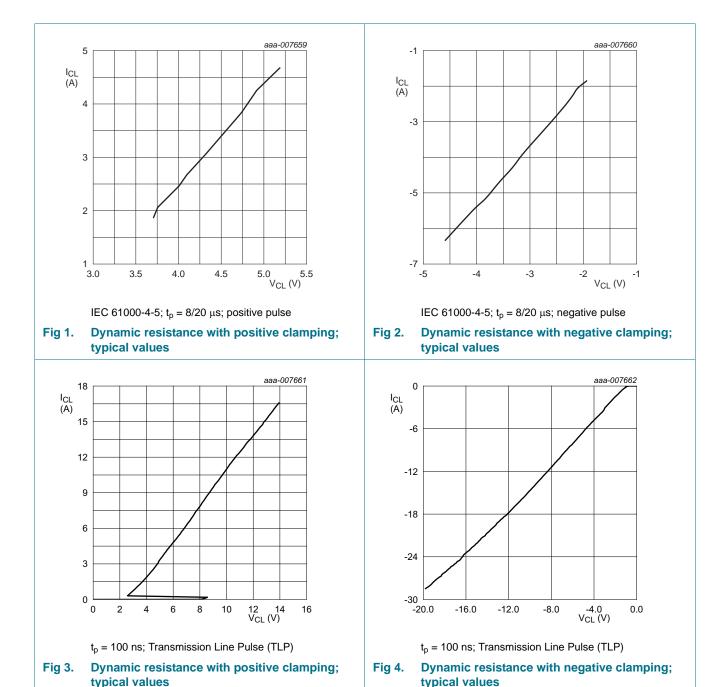
 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>s(ch)</sub>	channel series resistance	single line; input to output	-	5	-	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>I</sub> = 2.5 V	-	0.6	0.75	pF
I <sub>RM</sub>	reverse leakage current	per line; V <sub>I</sub> = 5 V	-	-	100	nA
$V_{BR}$	breakdown voltage	I <sub>R</sub> = 10 mA	6	-	9	٧
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 mA	0.6	-	1.1	٧
R <sub>dyn</sub>	dynamic resistance	TLP [2]				
		positive transient	-	0.6	-	Ω
		negative transient	-	0.6	-	Ω
		urge [3]				
		positive transient	-	0.6	-	Ω
		negative transient	-	0.6	-	Ω
V <sub>CL</sub>	clamping voltage	positive transient; I <sub>PP</sub> = 4 A [3]	-	4.8	-	٧
		negative transient; $I_{PP} = -5 \text{ A}$ [3]	-	-3.6	-	V
		TLP; I <sub>CL</sub> = 8 A	-	8	-	٧
		TLP; I <sub>CL</sub> = 12 A	-	10.5	-	٧
		TLP; I <sub>CL</sub> = 16 A	-	13.4	-	٧
		TLP; I <sub>CL</sub> = -8 A	-	-6	-	٧
		TLP; I <sub>CL</sub> = -12 A	-	-8.4	-	٧
		TLP; I <sub>CL</sub> = -16 A	-	-10.7	-	V

<sup>[1]</sup> This parameter is guaranteed by design.

<sup>[2] 100</sup> ns Transmission Line Pulse (TLP); 50  $\Omega$ ; pulser at 70 to 90 ns.

<sup>[3]</sup> According to IEC 61000-4-5 (8/20  $\mu$ s).



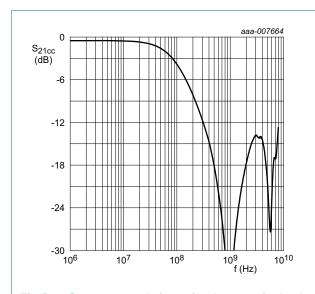
The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

### 6.2 Frequency characteristics

Table 7. Frequency characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Commor	mode: S <sub>21cc</sub>			,	'	'
$\alpha_{il}$	insertion loss	[1	1			
		f = 400 MHz	-	15	-	dB
		f = 800 MHz	-	30	-	dB
	f = 5 GHz	-	21	-	dB	
Different	ial mode: S <sub>21dd</sub>				'	,
$\alpha_{il}$	insertion loss	f = 1MHz [1	l <b>-</b>	0.6	-	dB
f_3dB	cut-off frequency	[1][2	l -	2.2	-	GHz

- [1] Measured with 4-port network analyzer;  $R_{gen}$  = 50  $\Omega$ ;  $R_{L}$  = 50  $\Omega$ .
- [2] Normalized to attenuation at 1 MHz.





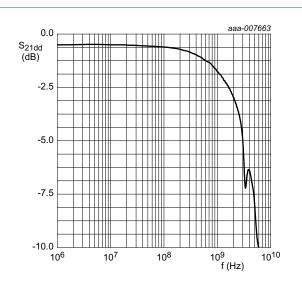
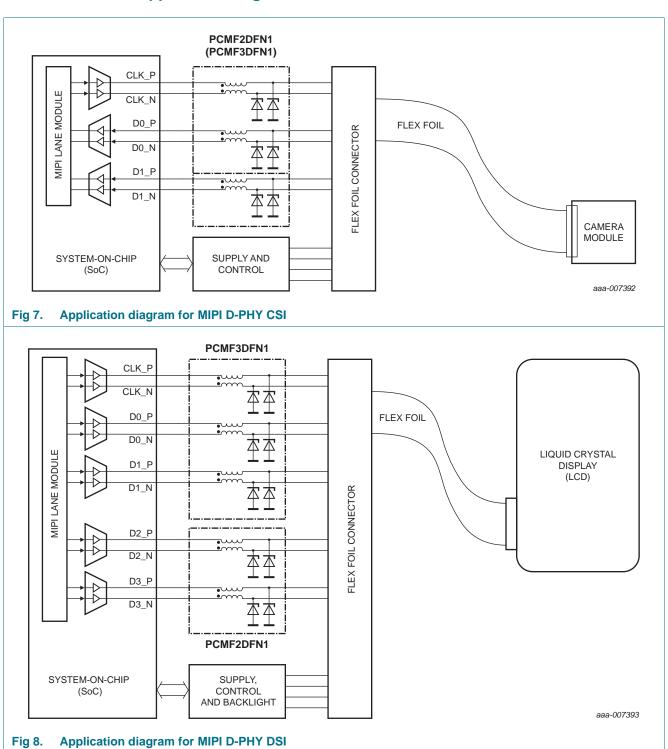


Fig 6. Differential-mode insertion loss; typical values

# 7. Application information

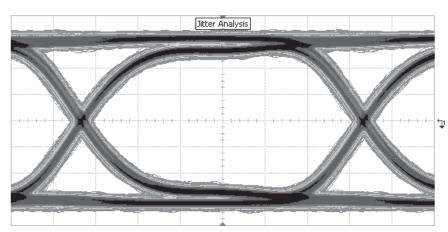
### 7.1 Application diagram



PCMF2DFN1\_PCMF3DFN1

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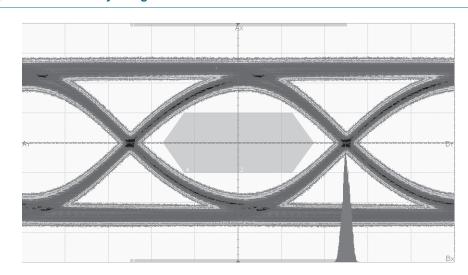
## 7.2 Eye diagram



aaa-007649

Data rate: 1.5 Gbit/s Vertical scale = 28.7 mV/div Horizontal scale = 100 ps/div

### Fig 9. MIPI D-PHY eye diagram

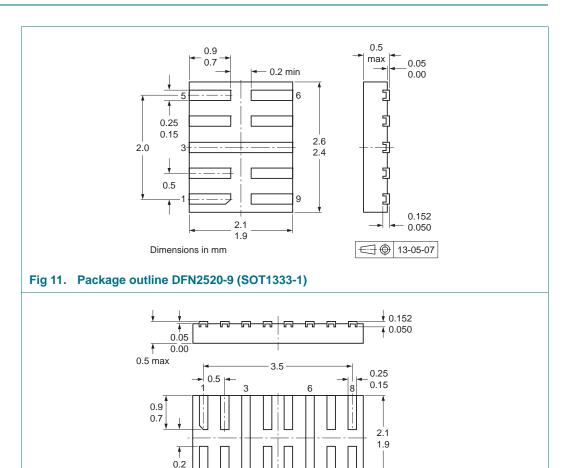


aaa-007648

Data rate: 3.4 Gbit/s Vertical scale = 200 mV/div Horizontal scale = 58.9 ps/div

Fig 10. HDMI eye diagram

# 8. Package outline



4.1

9

€ 13-05-07

Fig 12. Package outline DFN4020-14 (SOT1334-1)

14

Dimensions in mm

## 9. Soldering

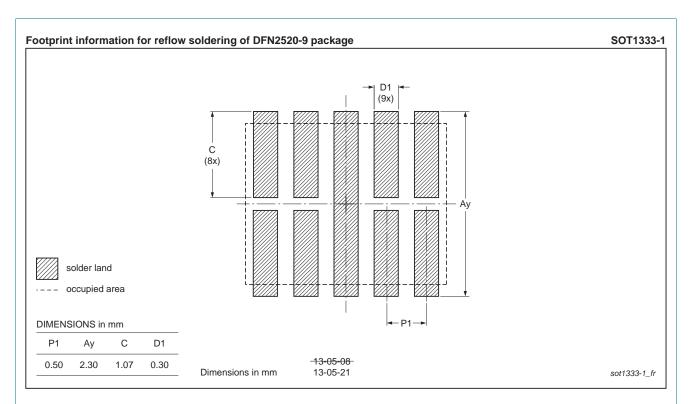
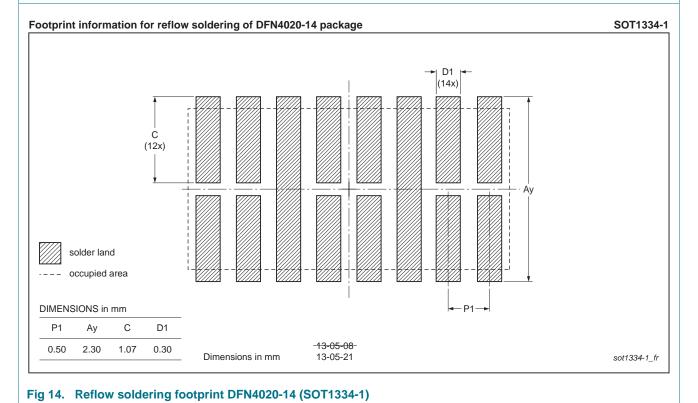


Fig 13. Reflow soldering footprint DFN2520-9 (SOT1333-1)



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Common-mode EMI filter for differential channels with ESD protection

# 10. Revision history

### Table 8. Revision history

Document ID	Release date		Change notice	Supersedes
PCMF2DFN1_PCMF3DFN1 v.2	20140428	Product data sheet	-	PCMF2DFN1_PCMF3DFN1 v.1
Modification:	<ul> <li>Surge rati</li> </ul>	ng adapted		
PCMF2DFN1_PCMF3DFN1 v.1	20130606	Product data sheet	-	-

#### Common-mode EMI filter for differential channels with ESD protection

### 11. Legal information

#### 11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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# PCMF2DFN1; PCMF3DFN1

Common-mode EMI filter for differential channels with ESD protection

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